

New!

Models 57862 & 58862

4 or 8-Channel 200 MHz A/D with Multiband DDCs and Kintex UltraScale FPGAs - 6U VPX



Model 58862



General Information

Models 57862 and 58862 are members of the Jade™ family of high-performance 6U VPX boards. The Jade architecture embodies a new streamlined approach to FPGA-based boards, simplifying the design to reduce power and cost, while still providing some of the highest-performance FPGA resources available today. Designed to work with Pentek's new Navigator™ Design Suite of tools, the combination of Jade and Navigator offers users an efficient path to developing and deploying FPGA-based data acquisition and processing.

These models consist of one or two Model 71862 XMC modules mounted on a VPX carrier board. Model 57862 is a 6U board with one Model 71862 module while the Model 58862 is a 6U board with two XMC modules rather than one.

They include four or eight A/Ds, complete multiboard clock and sync sections, and a large DDR4 memory. In addition to supporting PCI Express Gen. 3 as a native interface, these models include optional high-bandwidth connections to the Kintex UltraScale FPGA for custom digital I/O.

The Jade Architecture

Evolved from the proven designs of the Pentek Cobalt and Onyx families, Jade raises the processing performance with the new flagship family of Kintex UltraScale FPGAs from Xilinx. As the central feature of the board architecture, the FPGA has access to all data and control paths, enabling factory-installed functions including data multiplexing,

channel selection, data packing, gating, triggering and memory control. The Jade architecture organizes the FPGA as a container for data-processing applications where each function exists as an intellectual property (IP) module.

Each member of the Jade family is delivered with factory-installed applications ideally matched to the board's analog interfaces. The factory-installed functions include four or eight A/D acquisition IP modules for simplifying data capture and transfer.

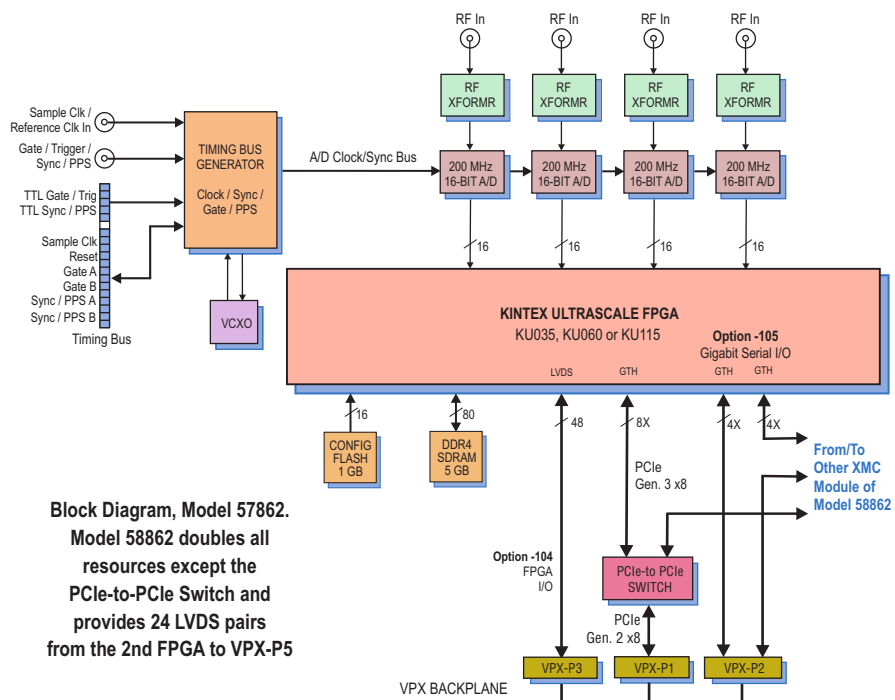
Each of the acquisition IP modules contains a powerful, programmable DDC IP core; IP modules for DDR4 SDRAM memory; controllers for all data clocking and synchronization functions; test signal generators; and a PCIe interface. These complete the factory-installed functions and enable these models to operate as complete turnkey solutions for many applications, thereby saving the cost and time of custom IP development.

Extendable IP Design

For applications that require specialized functions, users can install their own custom IP for data processing. The Pentek Navigator FPGA Design Kits include the board's entire FPGA design as a block diagram that can be edited in Xilinx's Vivado tool suite. In addition to the block diagrams, all source code and complete IP core documentation is included. Developers can integrate their own IP along with the Pentek factory-installed functions or use the Navigator kit to completely replace the Pentek IP with their own. ▶

Features

- Complete radar and software radio interface solution
- Supports Xilinx Kintex UltraScale FPGAs
- Four or eight 200 MHz 16-bit A/Ds
- Four or eight multiband DDCs
- 5 or 10 GB of DDR4 SDRAM
- Sample clock synchronization to an external system reference
- LVPECL clock/sync bus for multiboard synchronization
- PCI Express (Gen. 1, 2 & 3) interface up to x8
- Optional LVDS and gigabit serial connections to the FPGA for custom I/O
- Ruggedized and conduction-cooled versions available



A/D Acquisition IP Modules

These models feature four or eight A/D Acquisition IP Modules for easily capturing and moving data. Each IP module can receive data from any of the A/Ds or test signal generators.

Each IP module has an associated DMA engine for easily moving A/D data through the PCIe interface. These powerful linked-list DMA engines are capable of a unique Acquisition Gate Driven mode. In this mode, the length of a transfer performed by a link definition need not be known prior to data acquisition; rather, it is governed by the length of the acquisition gate. This is extremely useful in applications where an external gate drives acquisition and the exact length of that gate is not known or is likely to vary.

For each transfer, the DMA engine can automatically construct metadata packets containing A/D channel ID, a sample-accurate time stamp and data length information. These actions simplify the host processor's job of identifying and executing on the data.

DDC IP Cores

Within each A/D Acquisition IP Module are two powerful DDC IP cores. A single-channel wideband DDC core and an eight-channel multiband DDC core. Each Acquisition Module can choose between the two cores allowing for a very flexible downconversion solution.

Each wideband DDC has an independent 32-bit tuning frequency setting that ranges from DC to f_s , where f_s is the A/D sampling frequency. Each DDC can have its own unique decimation setting. Decimations can be programmed from 2 to 32.

Each multiband DDC has eight DDC channels each with its own independent 32-bit tuning frequency setting that ranges from DC to f_s , where f_s is the A/D sampling frequency. Decimations can be programmed from 2 to 1024.

The decimating filter for all DDCs accept a unique set of user-supplied 24-bit coefficients. The 80% default filters deliver an output bandwidth of $0.8 \cdot f_s / N$, where N is the decimation setting. The rejection of adjacent-band components within the 80% output bandwidth is better than 100 dB. Each DDC delivers a complex output stream consisting of 24-bit I + 24-bit Q or 16-bit I + 16-bit Q samples at a rate of f_s / N .

► Xilinx Kintex UltraScale FPGA

The Kintex UltraScale FPGA site can be populated with a range of FPGAs to match the specific requirements of the processing task, spanning the KU035 through KU115. The KU115 features 5520 DSP48E2 slices and is ideal for modulation/demodulation, encoding/decoding, encryption/decryption, and channelization of the signals between transmission and reception. For applications not requiring large DSP resources or logic, a lower-cost FPGA can be installed.

Option -104 provides 24 pairs of LVDS connections between the FPGA and the VPX P3 connector, Model 57862; P3 and P5 connectors, Model 58862.

Option -105 provides two 4X gigabit links between the FPGA and the VPX P2 connector to support serial protocols.

A/D Converter Stage

The front end accepts four analog HF or IF inputs on front panel SSMC connectors with transformer coupling into four or eight TI ADS5485 200 MHz, 16-bit A/D converters.

The digital outputs are delivered into the Kintex UltraScale FPGAs for signal-processing or routing to other board resources.

Clocking and Synchronization

An internal timing bus provides all timing and synchronization required by the A/D converters. It includes a clock, two sync and two gate or trigger signals. An on-board clock generator receives an external sample clock from the front panel SSMC connector. This clock can be used directly by the A/D or divided by a built-in clock synthesizer circuit.

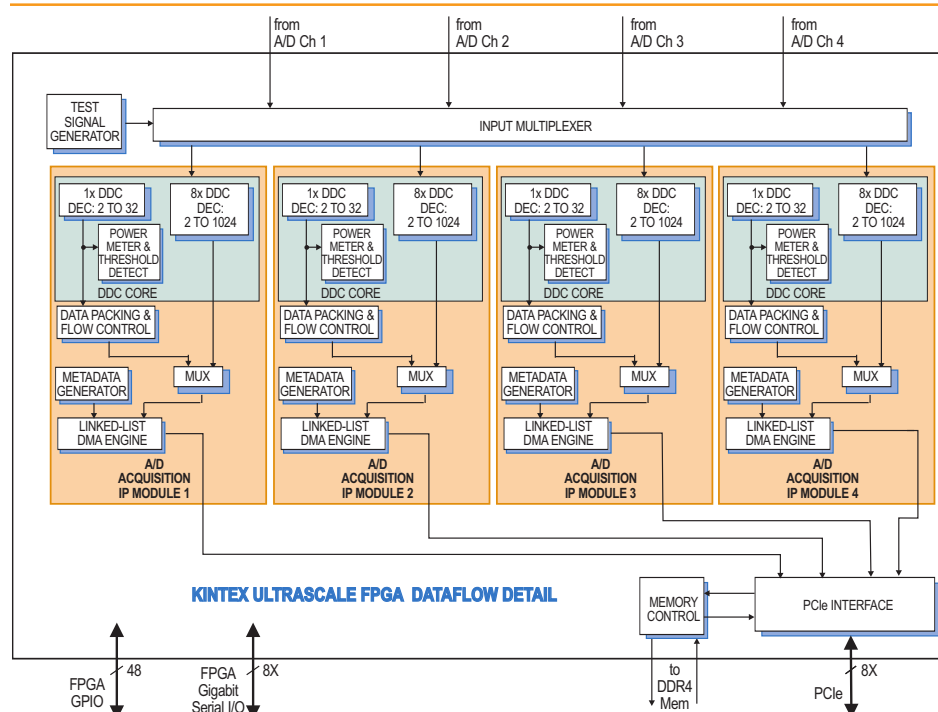
In an alternate mode, the sample clock can be sourced from an on-board programmable voltage-controlled crystal oscillator. In this mode, the front panel SSMC connector can be used to provide a 10 MHz reference clock for synchronizing the internal oscillator.

Front-panel 26-pin LVPECL Clock/Sync connectors allow multiple boards to be synchronized. In the slave mode, they accept LVPECL inputs that drive the clock, sync and gate signals. In the master mode, the LVPECL bus can drive the timing signals for synchronizing multiple boards.

Multiple boards can be driven from the LVPECL bus master, supporting synchronous sampling and sync functions across all connected boards.

Memory Resources

The architecture supports 5 or 10 GB banks of DDR4 SDRAM memory. User-installed IP along with the Pentek-supplied ►



SPARK Development Systems

The SPARK Development Systems are fully-integrated platforms for Pentek Cobalt, Onyx, Jade and Flexor boards. Available in a PCIe rackmount (Model 8266), a 3U VPX chassis (Model 8267), or a 6U VPX chassis (Model 8264), they were created to save engineers and system integrators the time and expense associated with building and testing a development system. Each SPARK system is delivered with the Pentek board(s) and required software installed and equipped with sufficient cooling and power to ensure optimum performance.



Ordering Information

Model	Description
57862	4-Channel 200 MHz A/D with multiband DDCs and Kintex UltraScale FPGA - 6U VPX
58862	8-Channel 200 MHz A/D with multiband DDCs and 2 Kintex UltraScale FPGAs - 6U VPX

Options:

- 084	XCKU060-2 FPGA
- 087	XCKU115-2 FPGA
-104	LVDS FPGA I/O to VPX P3, Model 57862; P3 and P5 Model 58862
-105	Gigabit serial FPGA I/O to VPX P2
- 702	Air cooled, Level L2
- 713	Conduction cooled, Level L3

Contact Pentek for complete specifications of rugged and conduction-cooled versions

► DDR4 controller core within the FPGA can take advantage of the memory for custom applications.

PCI Express Interface

These models include industry-standard interfaces fully compliant with PCI Express Gen. 1, 2 and 3 bus specifications. Supporting PCIe links up to x8, the interfaces include multiple DMA controllers for efficient transfers to and from the boards.

Specifications

Model 57862: 4 A/Ds; Model 58862: 8 A/Ds
Front Panel Analog Signal Inputs (4 or 8)

Input Type: Transformer-coupled, front panel female SSMC connectors
Transformer Type: Coil Craft WBC4-6TLB
Full Scale Input: +8 dBm into 50 ohms
3 dB Passband: 300 kHz to 700 MHz

A/D Converters (4 or 8)

Type: Texas Instruments ADS5485
Sampling Rate: 10 MHz to 200 MHz
Resolution: 16 bits

Wideband Digital Downconverters (4 or 8)

Decimation Range: 2x to 32x
LO Tuning Freq. Resolution: 32 bits, 0 to f_s
LO SFDR: >120 dB
Phase Offset Resolution: 32 bits, 0 to 360 degrees
FIR Filter: 24-bit coefficients, 24-bit output, user-programmable coefficients
Default Filter Set: 80% bandwidth, <0.3 dB passband ripple, >100 dB stopband attenuation

Multiband Digital Downconverters (4 or 8)

Decimation Range: 2x to 1024x
LO Tuning Freq. Resolution: 32 bits, 0 to f_s , independent tuning for each channel
LO SFDR: >120 dB
Phase Offset Resolution: 32 bits, 0 to 360 degrees
FIR Filter: 24-bit coefficients, 24-bit output, user-programmable coefficients
Default Filter Set: 80% bandwidth, <0.3 dB passband ripple, >100 dB stopband attenuation

Sample Clock Sources: (1 or 2)

On-board clock synthesizer

Clock Synthesizer (1 or 2)

Clock Source: Selectable from on-board programmable VCXO (10 to 810 MHz), front panel external clock or LVPECL timing bus

Synchronization: VCXO can be locked to an external 4 to 180 MHz PLL system reference, typically 10 MHz

Clock Dividers: External clock or VCXO can be divided by 1, 2, 4, 8, or 16 for the A/D clock

External Clock (1 or 2)

Type: Front panel female SSMC connector, sine wave, 0 to +10 dBm, AC-coupled, 50 ohms, accepts 10 to 800 MHz divider input clock or PLL system reference

Timing Bus (1 or 2)

26-pin connector LVPECL bus includes, clock/sync/gate/PPS inputs and outputs; TTL signal for gate/trigger and sync/PPS inputs

External Trigger Input (1 or 2)

Type: Front panel female SSMC connector, LVTTTL

Function: Programmable functions include: trigger, gate, sync and PPS

Field Programmable Gate Array (1 or 2)

Standard: Xilinx Kintex UltraScale XCKU035-2

Option -084: Xilinx Kintex UltraScale XCKU060-2

Option -087: Xilinx Kintex UltraScale XCKU115-2

Custom I/O

Option -104 provides 24 pairs of LVDS connections between the FPGA and the VPX P3 connector, Model 57862; P3 and P5 connectors, Model 58862, for custom I/O

Option -105 provides two 4X gigabit links between the FPGA and the VPX P2 connector to support serial protocols

Memory (1 or 2 banks)

Type: DDR4 SDRAM

Size: 5 GB or 10 GB

Speed: 1200 MHz (2400 MHz DDR)

PCI-Express Interface

PCI Express Bus: Gen. 1, 2 or 3: x4 or x8

Environmental

Standard: L0 (air cooled)

Operating Temp: 0° to 50° C

Storage Temp: -20° to 90° C

Relative Humidity: 0 to 95%, non-condensing

Option -702: L2 (air cooled)

Operating Temp: -20° to 65° C

Storage Temp: -40° to 100° C

Relative Humidity: 0 to 95%, non-condensing

Option -713: L3 (conduction cooled)

Operating Temp: -40° to 70° C

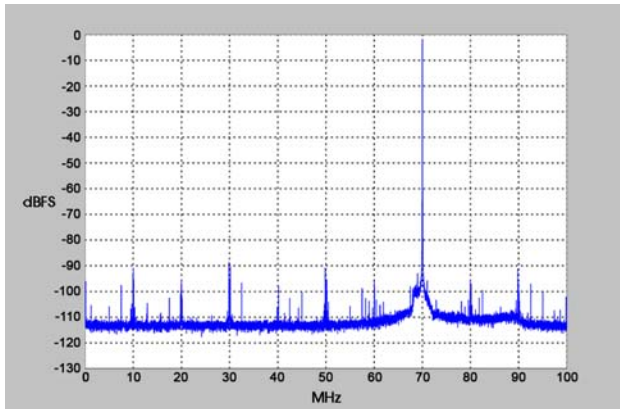
Storage Temp: -50° to 100° C

Relative Humidity: 0 to 95%, non-condensing

Size: Board 9.187 in x 6.717 in (233.35 mm x 170.60 mm) ►

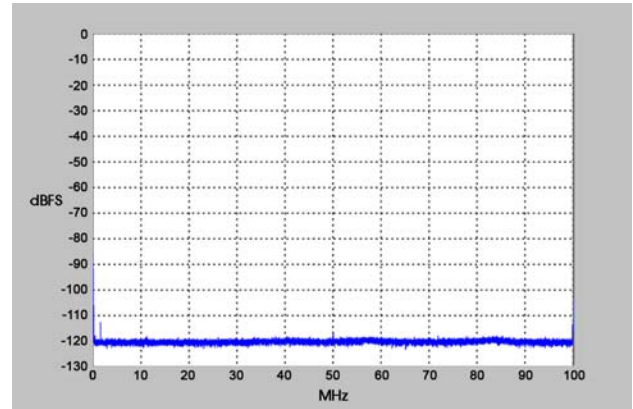
A/D Performance

Spurious Free Dynamic Range



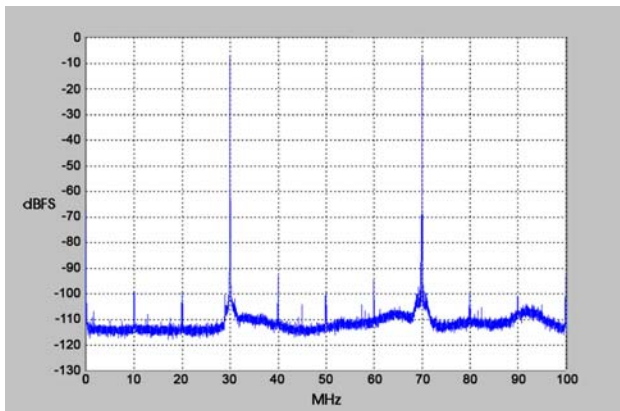
$f_{in} = 70 \text{ MHz}, f_s = 200 \text{ MHz}, \text{Internal Clock}$

Spurious Pick-up



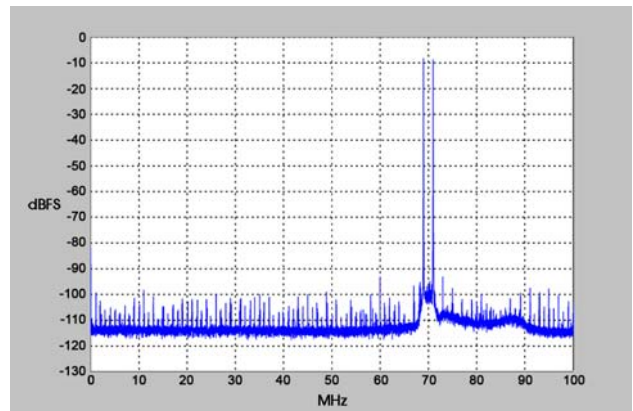
$f_s = 200 \text{ MHz}, \text{Internal Clock}$

Two-Tone SFDR



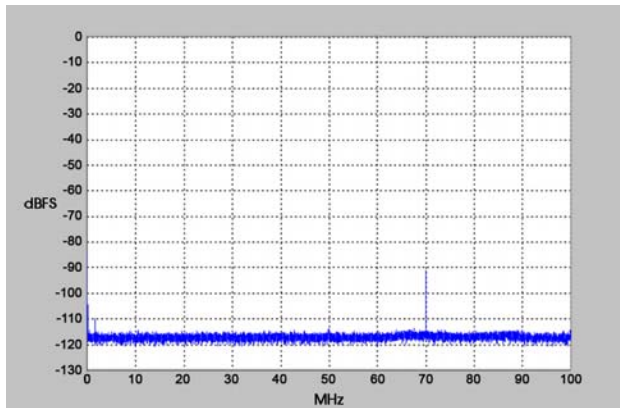
$f_1 = 30 \text{ MHz}, f_2 = 70 \text{ MHz}, f_s = 200 \text{ MHz}$

Two-Tone SFDR



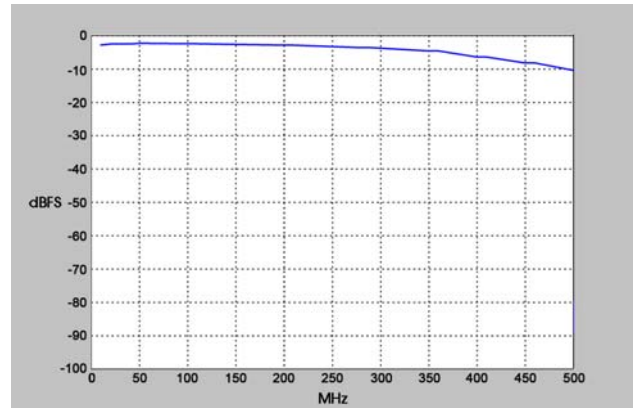
$f_1 = 69 \text{ MHz}, f_2 = 71 \text{ MHz}, f_s = 200 \text{ MHz}$

Adjacent Channel Crosstalk



$f_{in \text{ Ch2}} = 70 \text{ MHz}, f_s = 200 \text{ MHz}, \text{Ch 1 shown}$

Input Frequency Response



$f_s = 200 \text{ MHz}, \text{Internal Clock}$